

MINI-FIT SR. SERIES

1.0 SCOPE

This specification covers the 10.00 mm / (.394 in.) centerline tin and gold, silver plated connector series, single and dual row versions in wire to wire and wire to printed circuit board applications. This product performance is optimized for stranded tinned wire termination.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND <u>Product Name</u> Female Terminal Male Terminal Receptacle (single row) Plug (single row) Vertical Header (single Right Angle Header (single Receptacle (dual row) TPA (dual row) Vertical Header (dual row) Vertical Header (dual row) Vertical Header (single Right Angle Header (single)	row) ngle row) w) row) ngle row, 260°C reflow o	46984-****	d silver plati	
2.2 DIMENSIONS, MATER See the appropriate sal and markings.		RKINGS.	s, materials	, platings
2.3 SAFETY AGENCY APF File Numbers: UL File #E29179 CSA Certificate #I TUV Certificate #F	_R 19980-555			
3.0 APPLICABLE DOCUMENTS See sales drawings and referenced documents Application Specificatio	d the other sections of t and specifications.	-	e necessary	1
REVISION: ECR/ECN INFORMATION:		PECIFICATION FO		SHEET No.
B4 <u>EC No:</u> UCP2016-2078		CONNECTOR SYS		1 of 9
DATE:18 NOV 2015	CREATED / REVISED BY:	CHECKED BY:	APPRO	
PS-42815-001	M.COLE	B. ANDERSON	B. PISZ	
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FILENAME: PS42815.DOC



4.0 RATINGS

4.1 SAFETY AGENCY RATINGS

	Voltage (VAC (RMS) / VDC)				C	Current (A)		
Series	UL	CSA	TUV	UL	CS	A	ΤL	JV
				14AWG	12 AWG	10AWG	12AWG	10AWG
42818,	600V	600V	600V	N/A	23A	30A	23A	33A
43914								
42816,	600V	600V	250V	17A	23A	30A	23A	33A
42819,								
42820								
43915	600V	600V	None	N/A	23A	30A	None	None
43938	None	600V	600V	N/A	23A	30A	23A	33A

4.2 MOLEX CURRENT RATINGS

Molex rating is established based on MIL-W-5088 max. current capacity guidelines for copper conductors and test data summary TS-42815-001 section 5.3.7. Test data is based on 30 deg. C temperature rise using UL 1015 tinned stranded copper wire.

Single Row Product

	2ckt. W to W	2ckt. W to PCB**	4ckt. W to W	4ckt. W to PCB**	6ckt W to W	6ckt. W to PCB**
8 AWG	50A	48A	46A	44A	45A	37A
10 AWG	33A	33A	33A	33A	33A	33A
12 AWG	23A	23A	23A	23A	23A	23A
14 AWG	17A	17A	17A	17A	17A	17A
16 AWG	13A	13A	13A	13A	13A	13A

	2ckt.	2ckt.	4ckt.	4ckt.	6ckt	6ckt.
	W to W	W to PCB**	W to W	W to PCB**	W to W	W to PCB**
6mm ²	35A	-	-	-	-	-
5mm ²	35A	-	-	-	-	-

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4.2 MOLEX CURRENT RATINGS (continued)

	2ckt.	2ckt.	4ckt.	4ckt.	6ckt	6ckt.
	W to W	W to PCB**	W to W	W to PCB**	W to W	W to PCB**
12AWG	40A	40A				
Double Crimp	(20A per wire)	(20A per wire)	-	-	-	-

Dual Row Product

	6ckt. W to W	6ckt. W to PCB**	10ckt. W to W	10ckt. W to PCB**	14ckt W to W	14ckt. W to PCB**
8 AWG	43A	37A	40A	36.5A	38A	36A
10 AWG	32A	31A	31.5A	29.5A	29A	28A
12 AWG	23A	23A	23A	22.5A	23A	22A
14 AWG	17A	17A	17A	16.5A	17A	16A
16 AWG	13A	13A	13A	12.5A	13A	12A

**PCB trace design may greatly affect temperature rise results.

Ratings shown represent *MAXIMUM* current carrying capacity of a fully loaded connector with all circuits powered. Ratings are based on a 30°C maximum temperature rise limit over ambient (room temperature). Testing conducted with tinned copper conductor stranded wire. Above charts are intended as a guideline. Current rating is application dependent. Appropriate de-rating is required depending on factors such as higher ambient temperature, smaller copper weight of PCB traces, gross heating from adjacent modules or components and other factors that influence connector performance.

4.3 TEMPERATURES

Operating: -40 Degrees C to +105 Degrees C Non-operating: -40 Degrees C to +105 Degrees C (Including 30 degrees C terminal temperature at full current)

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PS	S-42815-001	M.COLE	B. ANDERSON	B. PISZ	CZOR
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5.0 PERFORMANCE

5.1 ELECTRICAL PERFORMANCE

Section	Item	Test Condition	Requirement
5.1.1	Initial Contact Resistance (low level)	Mate connectors, measure by dry circuit, 20mV max., 100mA. Wire resistance shall	1.5 mOhm max. (tin)
		be removed from the measured value.	1.0 mOhm max. (gold)
			1.5 mOhm max. (silver)
5.1.2	Insulation Resistance	Mate connectors, apply 500V DC between adjacent terminal or ground.	1000 M Ohm min.
5.1.3	Dielectric Strength	Mate connectors, apply 2200V AC for 1 minute between adjacent terminal or ground.	No breakdown
5.1.4	Contact Resistance (rated)	Measure contact resistance at rated current.	1.5 mOhm max. (tin) 1.0 mOhm max. (gold) 1.5 mOhm max. (silver)
5.1.5	Contact Resistance on Crimp	Crimp the wire to the terminal, measure crimp resistance by dry circuit, 20mV max., 100mA	1.0 mOhm max.

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5.2 MECHANICAL PERFORMANCE

Section	Item	Test Condition	Requirement
5.2.1	Contact Insertion and Withdrawal	Insert and withdraw a contact at a speed rate of 25 +/- 6mm / minute	Max. Insertion = 3Kg Min. Withdrawal = 0.25Kg
5.2.2	Connector Insertion and Withdrawal	Insert and withdraw a connector at a rate of 25 +/- 6mm / minute	Max. Insertion = 3.0Kg/ckt. Min. Withdrawal = 0.25Kg/ckt.
5.2.3	Terminal Insertion Force	Insert the crimped terminal into the housing.	Max. Insertion = 7.0Kg
5.2.4	Crimp Terminal Retention Force	Apply axial pull out force at a speed rate of 25 +/- 6mm / minute on the terminal assembled in the housing and with the TPA cover installed.	Min. Retention = 10Kg
5.2.5	Header Terminal Retention Force	Apply axial pull out force at a speed rate of 25 +/- 6mm / minute on the terminal assembled in the housing.	Min. Retention = 2.0Kg
5.2.6	Wire Pull Out Force	Mount the crimped terminal, apply an axial pull out force on the wire at a speed rate of 25 +/- 6mm / minute.	16AWG = 14Kg 14AWG = 23Kg 12AWG = 31Kg 10AWG = 36Kg 8AWG = 40Kg
5.2.7	Normal Force	Apply a perpendicular force at a speed rate of 25 +/- 6mm / minute.	200 g min.
5.2.8	PCB Insertion and Withdrawal Force	Apply force perpendicular to the housing at a speed rate of 25 +/- 6mm minute as shown.	Insertion = 2Kg max. Withdrawal = 1Kg min.
5.2.9	Panel Insertion & Withdrawal	Insert and withdraw a connector at a speed rate of 25 +/- 6mm / minute	Insertion = 5Kg max. Withdrawal = 10Kg min.

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5.2 MECHANICAL PERFORMANCE (continued)

Section	Item	Test Cond	ition	Requireme	nt
5.2.10	Latch Yield Strength (only 43914 receptacle w/ 43938 plug)	Insert and withdraw connector housings (30 times) and pull apart at a speed rate of 25 +/- 6mm / minute		Yield = 7.0Kg min.	
5.2.10A	Latch Yield Strength (all other)	Insert and withdraw connector housings (30 times) and pull apart at a speed rate of 25 +/- 6mm / minute		min.	
5.2.11	Durability (tin)	Insert and withdraw co (30 times) at a maximu cycles per minute prior environmental tests.	um rate of 10	Contact Res. change = 1.0mOhm max.	
5.2.11A	Durability (gold)	Insert and withdraw co (100 times) at a maxim cycles per minute prior environmental tests.	num rate of 10	Contact Res. change = 1.0mOhm max.	
5.2.11B	Durability (silver)	Insert and withdraw connectors (30 times) at a maximum rate of 10 cycles per minute prior to environmental tests.Contact Res. cha = 1.0 mOhm material			
5.2.12A	Vibration with lubrication (tin) (Nyogel 760G)	10-500HZ with a G Level of 10Contact Res chaDuration: 9 hours.Discontinuity notgreater than 1microsecond		ax	
5.2.12B	Vibration without lubrication (gold)	10-500HZ with a G Lev Duration: 9 hours.	vel of 10	Contact Res change =. 1.0mOhm max Discontinuity not greater than 1 microsecond	
5.2.12 C	Vibration with lubrication (silver)	10-500HZ with a G Level of 10Contact Res changeDuration: 9 hours.= 1.0 mOhm maxDiscontinuity not greater than 1 microsecond			ax
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5.2.13 Mechanical Shock	0 G, 11ms, Half-Sine Shock Pulse.	Contact Res. change = 1.0mOhm max. Discontinuity not greater than 1 microsecond
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* NOTE: Thermal cycling, vibration and other factors can cause micro-motion within a mated connection. Micro-motion without lubricant could lead to fretting corrosion on tin plating. Due to the many factors that may be present in an application, Molex highly recommends the use of lubrication with Mini-Fit Sr tin-plated terminals for reliability assurance. See AS-42815-001 for more information

5.3 ENVIRONMENTAL PERFORMANCE

Section		Test Condition	Requirement
5.3.1	Cold Resistance	-40 +/- 3 degrees C for 96 hrs.	Appearance: No damage Contact Res. change = 1.0mOhm max.
5.3.2	Thermal Shock	Mate connectors, expose to 25 cycles of: -40 +0/-3 deg. C for 30 minutes +25 +/- 10 deg. C for 5 minutes max. +105 +3/-0 deg. C for 30 minutes	Appearance: No damage Contact Res. change
5.3.3	Thermal Aging	+25 +/- 10 deg. C for 5 minutes max. Mate connectors, expose to 240 hours at 105 +/- 2 deg. C	= 1.0mOhm max. Appearance: No damage
			Contact Res. change = 1.0mOhm max
5.3.4	Humidity (Steady State)	Mate connectors, expose to a temperature of 40 +/- 2 deg. C with a relative humidity of 90% to 95% for 96 hours.	Appearance: No damage Contact Res. change = 1.0mOhm max Dielectric withstanding voltage: No breakdown Insul. res: 1000M Ohm min.
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5.3 ENVIRONMENTAL PERFORMANCE (cont.)

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5.3.8	Solderability**	Per SMES-152	Solder coverage 95% MINIMUM SMES-152)	
5.3.7	Temp. Rise & Current Cycling	Mate the connectors and measure the temperature rise at the rated current for 96 hrs., 45 minutes ON and 15 minutes OFF for 240 hrs., and an additional 96 hrs. of steady-state current.	Max. Temp. Rise 30deg. C Per EIA 364 and requirement	
5.3.6 A	Immunity to Fretting Corrosion with lubrication. Silver	Mate connectors, expose to 500 cycles with a max. transition time of 5 minutes between extremes. +15 +/- 3 deg. C for 30 minutes +85 +/-3 deg. C for 30 minutes	Appearance: No damage Contact Res. ch = 1.0mOhm max	ange
5.3.6	Immunity to Fretting Corrosion with Iubrication. (tin) (Nyogel 760G)	Mate connectors, expose to 500 cycles with a max. transition time of 5 minutes between extremes. +25 +/- 10 deg. C for 30 minutes +70 +3/-0 deg. C for 30 minutes	Appearance: No damage Contact Res. ch = 1.0mOhm max	ange
5.3.5A	Cyclic Temperature & Humidity- Silver	Mate connectors: cycle per EIA-364- 31: 24 cycles at temperature $25 \pm 3^{\circ}$ C at $80 \pm 5^{\circ}$ relative humidity and $65 \pm$ 3° C at $50 \pm 5^{\circ}$ relative humidity; dwell time of 1.0 hour; ramp time of 0.5 hours.	Appearance: No damage Contact Res. chi = 1.0 mOhm ma Dielectric withsta voltage: No breakdown Insul. res: 1000M min.	ange x anding
5.3.5	Humidity (cyclic) (Tin and Gold Plated parts)	Mate connectors, expose to 25 cycles at 90% to 95% relative humidity with a transition time of 2.5 hrs. between extremes. +25 +/- 10 deg. C for 5 minutes max. +65 +3/-0 deg. C for 30 minutes	Appearance: No damage Contact Res. ch = 2.0mOhm may Dielectric withsta voltage: No brea Insul. res: 1000M min.	ange anding kdown I Ohm

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5.3.9	Reflow Solder Heat Resistance	Reflow solder process: 235°C max per AS-40000-5013	da Dii Cc	pearance: No mage mensional: onformance to sales awing requirements.
5.3.9A	Reflow Solder Heat Resistance: applicable to 46984 & 46986 with gold & Silver plating ONLY	Reflow solder process: 260°C max per AS-40000-5013	da Din Cc	ppearance: No mage mensional: onformance to sales awing requirements.
5.3.10	Wave Solder Heat Resistance	Dip header terminal tail Solder Duration: 3 +/- 0 Solder Temperature.: 2 Per AS-40000-5013).5 seconds da	ppearance: No mage
5.3.11	Resistance to Solvents	Solvent: flourinert FC-7 (3M Corp.) Solvent temp: Boiling t Immersion time: 120 + Solvent: Alpha 1003 (A Solvent: Isopropyl Alco Solvent Temp.: Boiling Immersion time: 240 +/ Repeat in solvent 5 tim deionized water betwee	da /- 5 seconds /- 5 seconds lpha Metal) hol temp. - 5 seconds es. Rinse with	pearance: No mage
** <u>NOTE</u> :	Always mate heade	patible with lead-free ha er to receptacle or plug to Silver, Gold to Gold and	o receptacle only wit	
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